AUG 0 9 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

LICANT:

YOSHIDA, AKITO

DOCKET NO.:

W2K1077

SERIAL NO:

10/082,472

EXAMINER:

ZARNEKE

FILED:

02/22/2002

ART UNIT:

2827

TITLE:

A STACKING STRUCTURE FOR SEMICONDUCTOR DEVICES USING A FOLDED OVER FLEXIBLE SUBSTRATE AND METHOD

THEREFOR

Mail Stop: Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Weiss, Moy & Harris, P.C. 4204 N. Brown Avenue Scottsdale, AZ 85251-3989

August 6, 2004

I hereby certify that on the  $6^{th}$  day of August, 2004, this correspondence is being deposited with the U.S. Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450 Alexandria, VA 22313-1450.

AMENDMENT LETTER

Dear Sir:

This is in response to an Office Action dated May 11.

2004 in regards to the above identified patent application. Please amend the subject patent application as follows: